

IEEE JRFID Special Issue on IEEE DTPI 2023

This special issue is intended to promote results presented at the **3th annual IEEE International Conference on Digital Twins and Parallel Intelligence (DTPI 2023)** held from October 16th, 2023 to November 9th, 2023 in Macau, SARC and Florida, USA, with more depth and details at the journal article level with archival value. The submitted papers will undergo peer review similar to regular JRFID papers.

The manuscript **must be significantly extended** beyond the scope of the conference paper in terms of the overall technical contents and research results (a similarity percent match less than 30% is mandatory).

The submission deadline is January 31, 2024. Nevertheless, submissions in advance with respect to the deadline are strongly encouraged, since the accepted manuscripts will be published as Early Access documents on IEEE Xplore as soon as the final files are submitted by the authors.

Submission guidelines

The following requirements must be accounted for when submitting the manuscript:

1. The **manuscript must be technically extended** beyond the contents of the conference paper. The novelty aspects with respect to the conference paper must to be properly discussed and highlighted, through the text. Additionally, the authors must provide in the **Cover Letter** detailed information on how the manuscript is a technically-extended version of the conference paper.
2. In the manuscript, the **conference paper must be listed** as one of the references and clearly referred. A **pdf copy of the conference paper** must also be submitted.

The manuscript, together with the accompanying documents (i.e. cover letter, conference paper and IEEE copyright transfer form), must be submitted electronically using the Manuscript Central website <https://mc.manuscriptcentral.com/jrfid>, according to the format available at <https://journals.ieeeauthorcenter.ieee.org/>.

When uploading the manuscript select for your manuscript the following TYPE: “**IEEE DTPI 2023 Conference**”. Subsequently, do not forget to **upload both the Cover Letter and the conference paper as “Supplemental Files for Review”**. Failure to follow above request will result in the immediate return of the manuscript to the author(s) as an unacceptable submission. For any questions on the submission process, please contact the Editor-in-Chief of IEEE JRFID, Prof. Paolo Nepa (paolo.nepa@unipi.it) or the Guest Editors.

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IMPORTANT DATES:

Submission deadline: JANUARY 31, 2024 **Publication of the Special Issue: mid 2024**